

MSKSEMI 美森科

SEMICONDUCTOR



ESD



TVS



TSS



MOV



GDT



PLED

SSL34F-MS

Product specification

FEATURES

- Ideal for surface mount applications
- Easy pick and place
- Built-in strain relief
- Low forward voltage drop
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- Easy pick and place
- Built-in strain relief
- Low forward voltage drop

MACHANICAL DATA

- Case: Molded plastic
- Epoxy: UL 94V-0 rate flame retardant
- Metallurgically bonded construction
- Polarity: Color band denotes cathode end
- Mounting position: Any


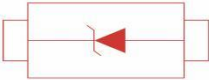
● **VOLTAGE RANGE**

40 Volts

● **CURRENT**

3.0 Ampere

Reference News

PACKAGE OUTLINE	PIN CONFIGURATION	Marking
 SMAF		<div>SSL34F</div>

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25 °C ambient temperature unless otherwise specified.

Single phase half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

TYPE NUMBER	SSL34F-MS	UNITS
Maximum Recurrent Peak Reverse Voltage	40	V
Maximum RMS Voltage	28	V
Maximum DC Blocking Voltage	40	V
Maximum Average Forward Rectified Current See Fig. 1	3.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	50	A
Maximum Instantaneous Forward Voltage at 2.0A	0.46	V
Maximum DC Reverse Current Ta=25 °C	0.2	mA
at Rated DC Blocking Voltage Ta=125 °C	30	mA
Typical Junction Capacitance (Note1)	240	pF
Typical Thermal Resistance RJA (Note 2)	88	C/W
Operating Temperature Range Tj	-55 to +125	°C
Storage Temperature Range Tstg	-55 to +150	°C

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. P.C.B. mounted with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

RATING AND CHARACTERISTIC CURVES (SSL34F-MS)

FIG.1-FORWARD CURRENT DERATING CURVE

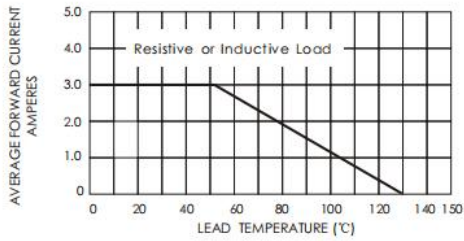


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

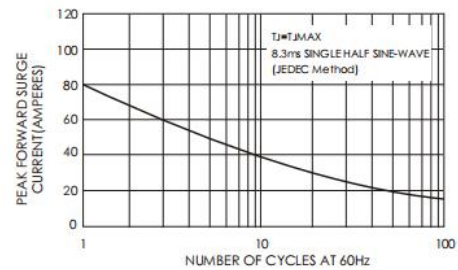


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

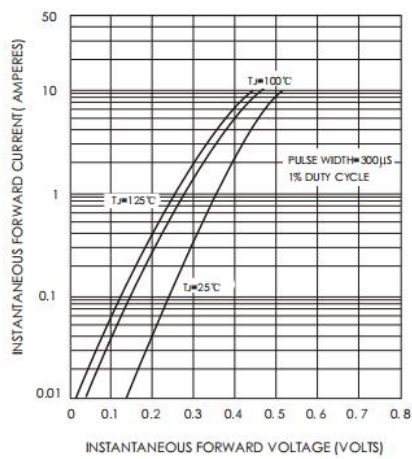


FIG.4-TYPICAL REVERSE CHARACTERISTICS

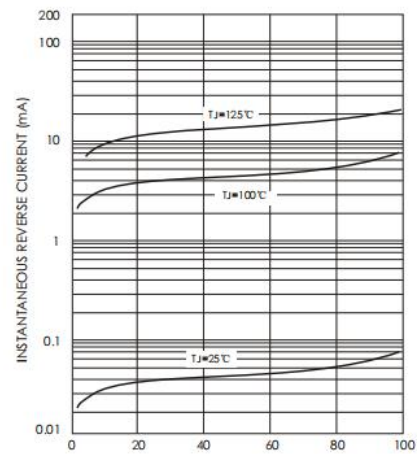
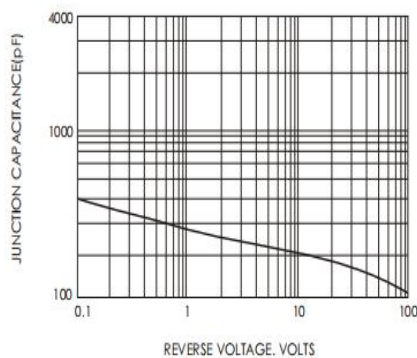
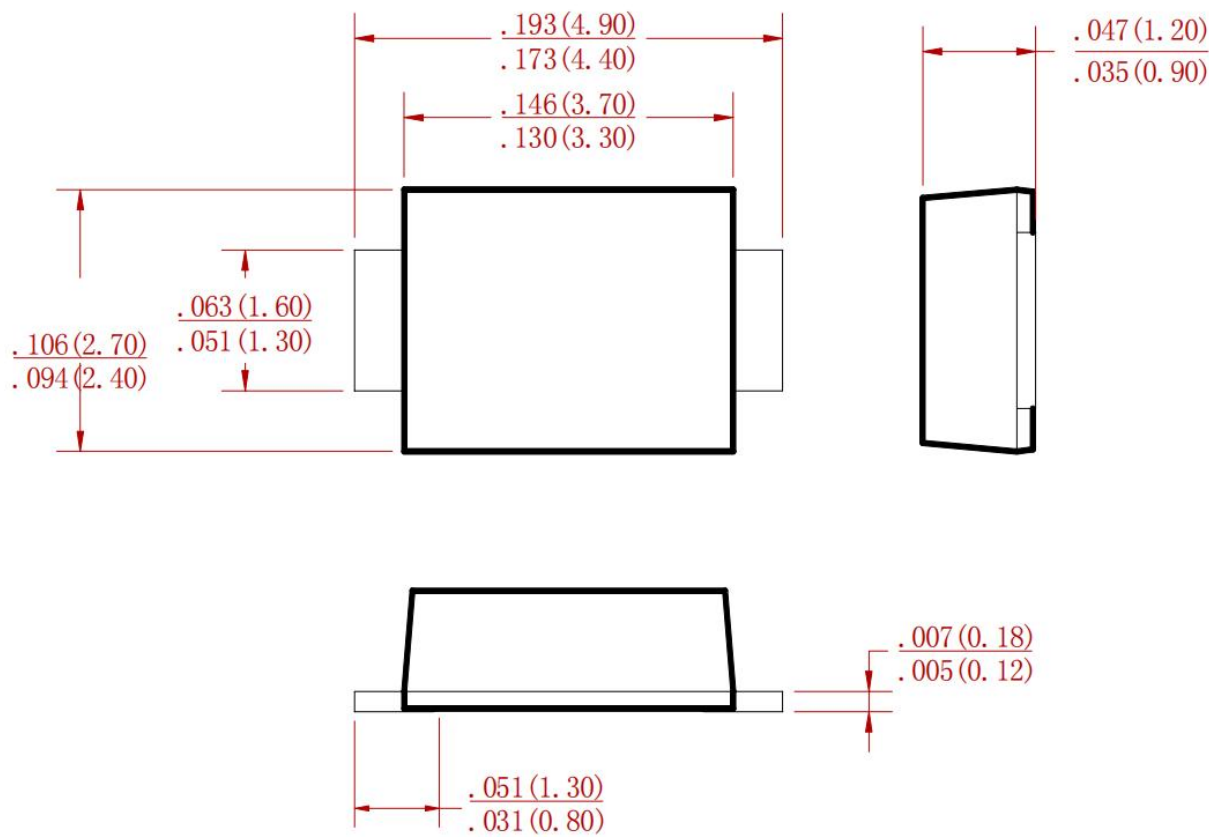


FIG.5-TYPICAL JUNCTION CAPACITANCE



PACKAGE MECHANICAL DATA



Dimensions in inches and (millimeters)

REEL SPECIFICATION

P/N	PKG	QTY
SSL34F-MS	SMAF	3000

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